



In series

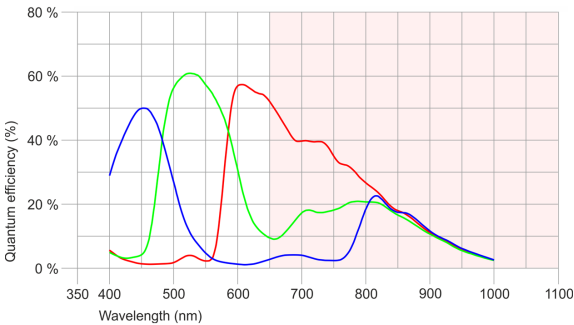
The model is in series and available for the long term.



Specification

Sensor

Sensor type	CMOS Color
Shutter	Global Shutter
Sensor characteristic	Linear
Pixel Class	9 MP
Resolution	8.95 Mpix
Resolution (h x v)	4112 x 2176 Pixel
Aspect ratio	17:9
ADC	12 bit
Color depth (camera)	12 bit
Optical sensor class	1"
Optical Size	14.159 mm x 7.500 mm
Optical sensor diagonal	16.02 mm 1"
Pixel size	3.45 µm
CRA (Chief Ray Angle)	0 °
Manufacturer	Sony
Sensor Model	IMX255LQR-C
Gain (master/RGB)	25.4x/16x
AOI horizontal	same frame rate
AOI vertical	increased frame rate
AOI image width / step width	256 / 2
AOI image height / step width	2 / 2
AOI position grid (horizontal/vertical)	2 / 2
Binning horizontal	-
Binning vertical	-
Binning method	Horizontal: addition / Vertical: addition
Binning factor	-
Decimation (subsampling) horizontal	increased frame rate
Decimation (subsampling) vertical	increased frame rate
Decimation (subsampling) method	M/C automatic
Decimation (subsampling) factor	2x2



Model

Frame rate freerun mode	61 fps*
Frame rate trigger (continuous)	62 fps
Frame rate trigger (maximum)	62 fps
Exposure time (minimum - maximum)	0.021 ms - 2000 ms
Long exposure (maximum)	90000 ms
Line rate freerun mode (line scan)	2734 1/s
Line rate trigger mode (line scan)	2950 1/s
Lines per frame (line scan)	8000
Power consumption	10 W - 14 W
Image memory	2032 MB

* Maximum frame rate achievable with upcoming firmware to be released shortly. For now, the maximum frame rate has to remain at 50 fps.

HDR

Mode	Sequencer
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Ambient conditions

The temperature values given below refer to the outer device temperature of the camera housing.

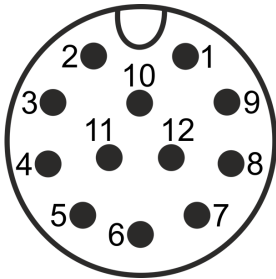
Allowed device temperature during operation	0 °C - 55 °C / 32 °F - 131 °F
Allowed ambient temperature during storage	-20 °C - 60 °C / -4 °F - 140 °F
Humidity (relative, non-condensing)	20 % - 80 %

Connectors

Interface connector	GigE RJ45, screwable
I/O connector	12-pin M12 connector (Attend 216A-12MSR)
Power supply	12 V - 24 V or PoE+

Pin assignment I/O connector

1	Power supply, 12-24 V DC
2	Power supply, ground
3	(Trigger) input 0 with optocoupler - Line0
4	Reference level for all optocoupler outputs
5	Reference level for all optocoupler inputs
6	(Trigger) input 1 with optocoupler - Line1
7	(Flash) output 1 with optocoupler - Line4
8	Fast (flash) output 2 with optocoupler - Line5
9	Power supply for fast (flash) outputs, 3-5 V DC
10	Fast (flash) output 3 with optocoupler - Line6
11	(Trigger) input 2 with optocoupler - Line2
12	(Flash) output 0 with optocoupler - Line3



Design

Lens Mount	C-Mount
IP code	IP30
Dimensions H/W/L	60.0 mm x 75.0 mm x 94.5 mm
Mass	550 g
Housing material	Aluminum

Features

List of on-camera image pre-processing features.

All features of the table are available via our IDS peak software for image pre-processing on the host computer (sensor model dependent).

Image Acquisition	Freerun	✓
	Software trigger	✓
	Hardware trigger	✓
	Trigger controlled exposure	✓
	Denoiser	✓
	Long exposure	✓
	Line scan	✓
Flashing	Flashing	✓
	PWM flashing	✓
Image Adjustments	Auto exposure	✓
	Auto gain	✓
	Auto whitebalance	✓
	Color correction	✓
	Gamma	✓
	LUT	✓
	Mirror/flip	X/Y
On-board Image Processing	Pixel formats	Mono8 BayerRG8 BayerRG10 BayerRG10p BayerRG12 BayerRG12p BGR8 RGB8 BGR10p32 RGB10p32
	Region of interest	✓
	Decimation (FPGA)	✓
	Decimation (Sensor)	2x2
	Binning (FPGA)	✓
	Binning (Sensor)	
Others	IP settings	✓
	Bandwidth management	✓
	Chunks	✓
	Sequencer	-
	PTP	✓
	Firmware update	✓
	1st supported firmware version	3.0